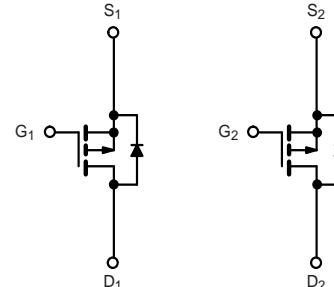


## PRODUCT SUMMARY

- $V_{DS}$  (V) = -60V
- $R_{DS(ON)} < 59\text{m}\Omega$  ( $V_{GS} = -10\text{V}$ )
- $R_{DS(ON)} < 69\text{ m}\Omega$  ( $V_{GS} = -4.5\text{V}$ )

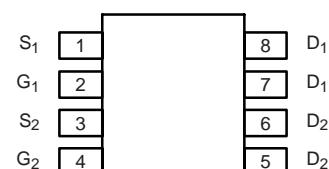


P-Channel MOSFET

P-Channel MOSFET

## APPLICATIONS

Load Switches



SOP-8

## ABSOLUTE MAXIMUM RATINGS $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	- 60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current ( $T_J = 150\text{ }^\circ\text{C}$ )	$I_D$	- 5.3 <sup>e</sup>	A
		- 5.0 <sup>e</sup>	
		- 5.3 <sup>a, b</sup>	
		- 5.0 <sup>a, b</sup>	
Pulsed Drain Current	$I_{DM}$	- 32 <sup>e</sup>	A
Continuous Source-Drain Diode Current	$I_S$	- 4.1	
		- 2.0 <sup>a, b</sup>	
Avalanche Current	$I_{AS}$	- 20	mJ
Single-Pulse Avalanche Energy	$E_{AS}$	20	
Maximum Power Dissipation	$P_D$	4.0	W
		2.5	
		2.0 <sup>a, b</sup>	
		1.4 <sup>a, b</sup>	
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	- 55 to 150	°C

## THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a, c</sup>	$R_{thJA}$	38	50	°C/W
Maximum Junction-to-Foot	$R_{thJF}$	20	25	

Notes:

- Surface mounted on 1" x 1" FR4 board.
- $t \leq 10\text{ s}$ .
- Maximum under Steady State conditions is 85 °C/W.
- Based on  $T_C = 25\text{ }^\circ\text{C}$ .
- Limited by package.

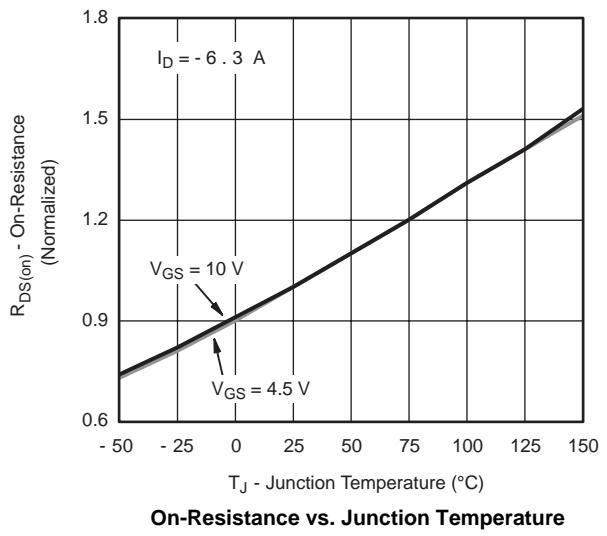
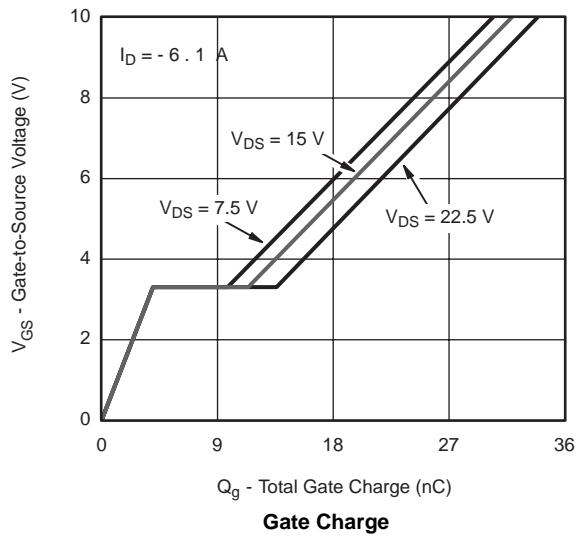
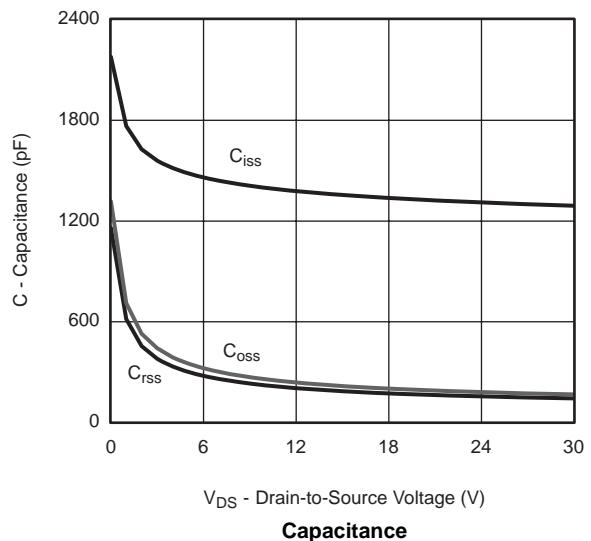
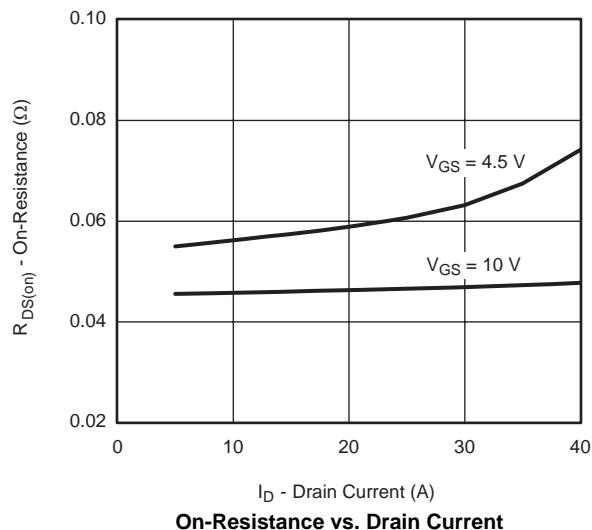
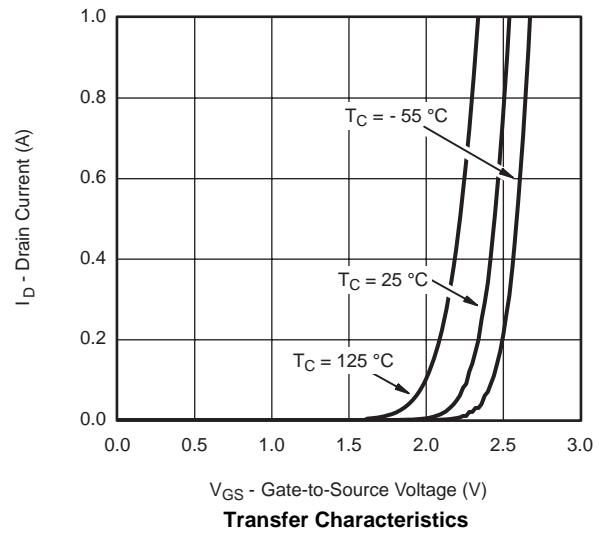
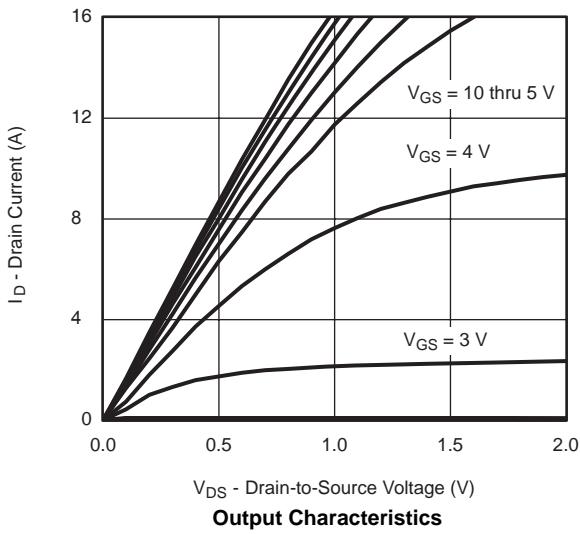
**SPECIFICATIONS**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 60			V
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = -250 \mu\text{A}$		- 31		mV/°C
$V_{GS(\text{th})}$ Temperature Coefficient	$\Delta V_{GS(\text{th})}/T_J$			4.5		
Gate-Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	- 1.0		- 3.0	V
Gate-Source Leakage	$I_{GSS}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	$\mu\text{A}$
		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$			- 5	
On-State Drain Current <sup>a</sup>	$I_{D(\text{on})}$	$V_{DS} \geq -10 \text{ V}, V_{GS} = -10 \text{ V}$	- 30			A
Drain-Source On-State Resistance <sup>a</sup>	$R_{DS(\text{on})}$	$V_{GS} = -10 \text{ V}, I_D = -6.3 \text{ A}$		54		mΩ
		$V_{GS} = -4.5 \text{ V}, I_D = -6.2 \text{ A}$		60		
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = -10 \text{ V}, I_D = -6.1 \text{ A}$		23		S
<b>Dynamic<sup>b</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		1345		pF
Output Capacitance	$C_{oss}$			210		
Reverse Transfer Capacitance	$C_{rss}$			180		
Total Gate Charge	$Q_g$	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -6.1 \text{ A}$		32	50	nC
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -6.1 \text{ A}$		15	25	
Gate-Drain Charge	$Q_{gd}$			4		
Gate Resistance	$R_g$			7.5		
Turn-On Delay Time	$t_{d(\text{on})}$	$V_{DD} = -15 \text{ V}, R_L = 15 \Omega$ $I_D \geq -1 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$		5.8		Ω
Rise Time	$t_r$			10	15	ns
Turn-Off DelayTime	$t_{d(\text{off})}$			8	15	
Fall Time	$t_f$			45	70	
Turn-On Delay Time	$t_{d(\text{on})}$	$V_{DD} = -15 \text{ V}, R_L = 15 \Omega$ $I_D \geq -1 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		12	25	
Rise Time	$t_r$			42	70	
Turn-Off DelayTime	$t_{d(\text{off})}$			35	60	
Fall Time	$t_f$			40	70	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Source-Drain Diode Current	$I_S$	$T_C = 25^\circ\text{C}$			- 4.1	A
Pulse Diode Forward Current	$I_{SM}$				- 32	
Body Diode Voltage	$V_{SD}$	$I_S = -2 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.75	- 1.2	V
Body Diode Reverse Recovery Time	$t_{rr}$	$I_F = -2 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}, T_J = 25^\circ\text{C}$		34	60	ns
Body Diode Reverse Recovery Charge	$Q_{rr}$			22	40	
Reverse Recovery Fall Time	$t_a$			11		ns
Reverse Recovery Rise Time	$t_b$			23		

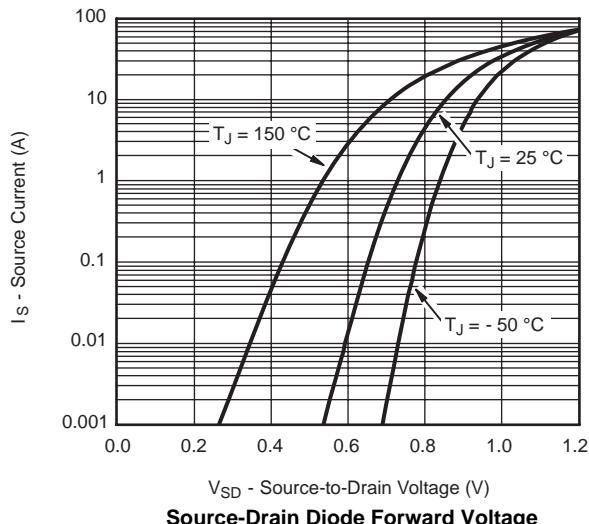
Notes:

- a. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .
- b. Guaranteed by design, not subject to production testing.

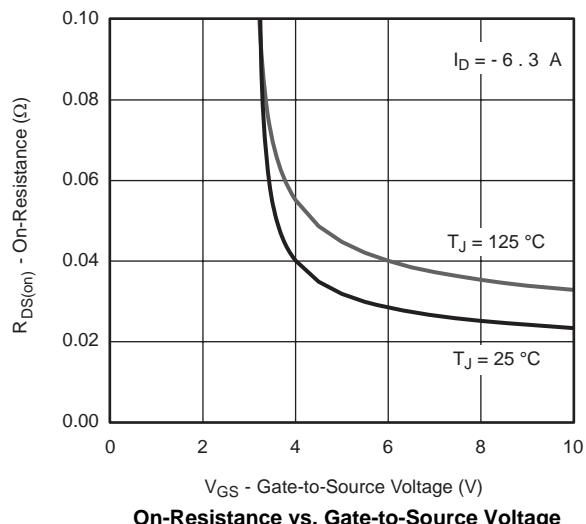
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



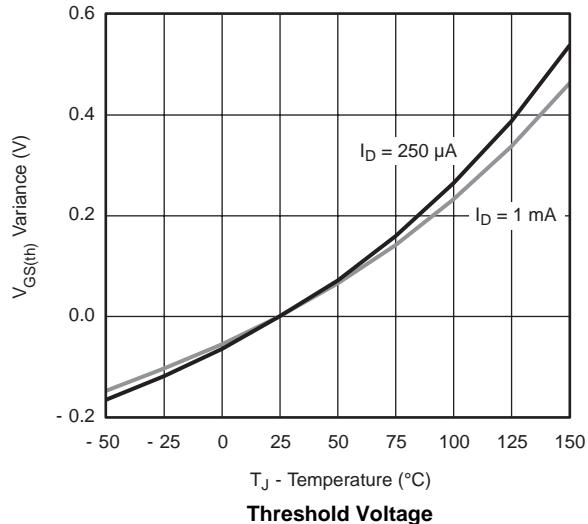
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



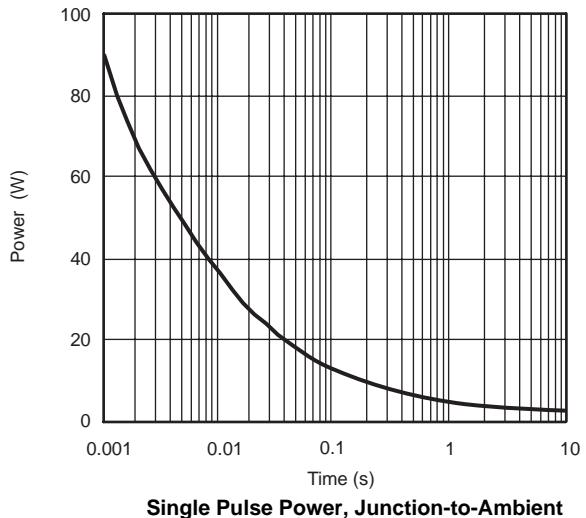
**Source-Drain Diode Forward Voltage**



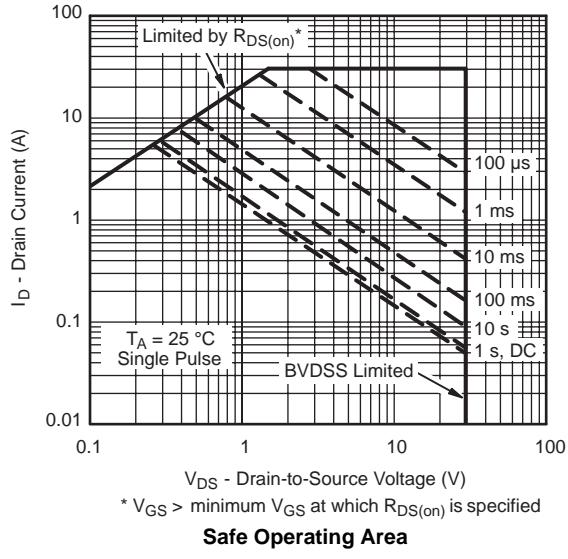
**On-Resistance vs. Gate-to-Source Voltage**



**Threshold Voltage**

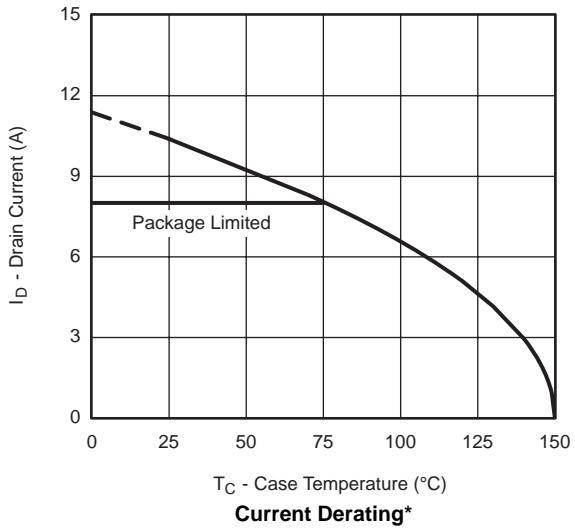


**Single Pulse Power, Junction-to-Ambient**



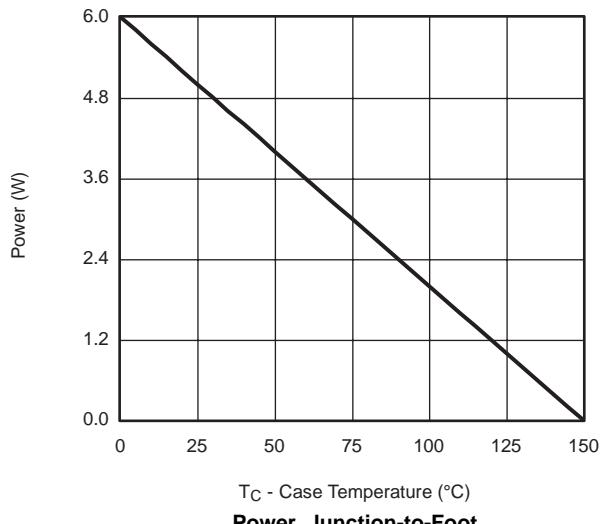
**Safe Operating Area**

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



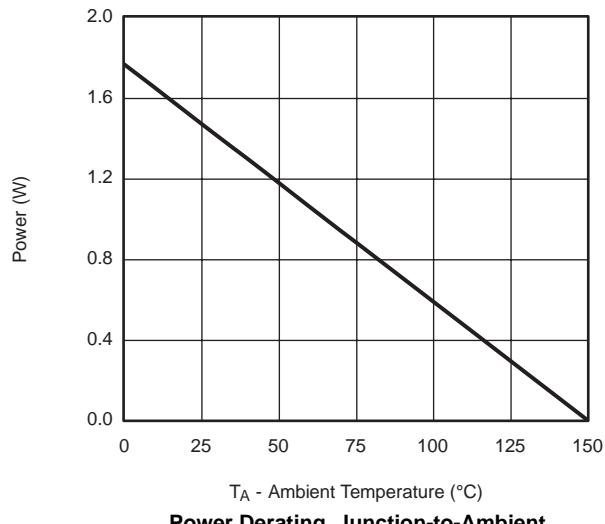
T<sub>C</sub> - Case Temperature (°C)

**Current Derating\***



T<sub>C</sub> - Case Temperature (°C)

**Power, Junction-to-Foot**

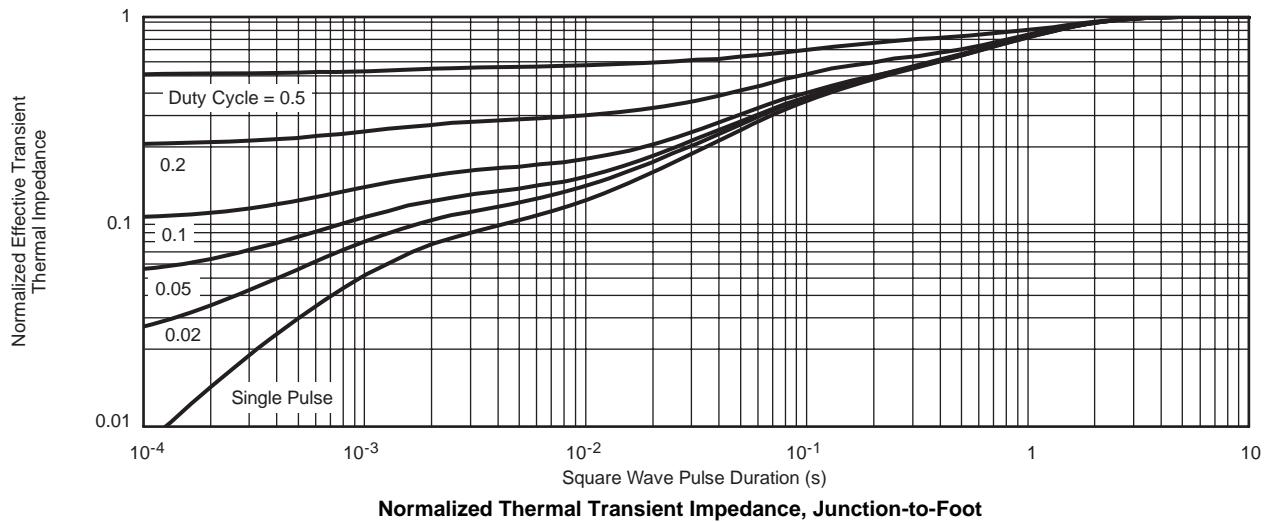
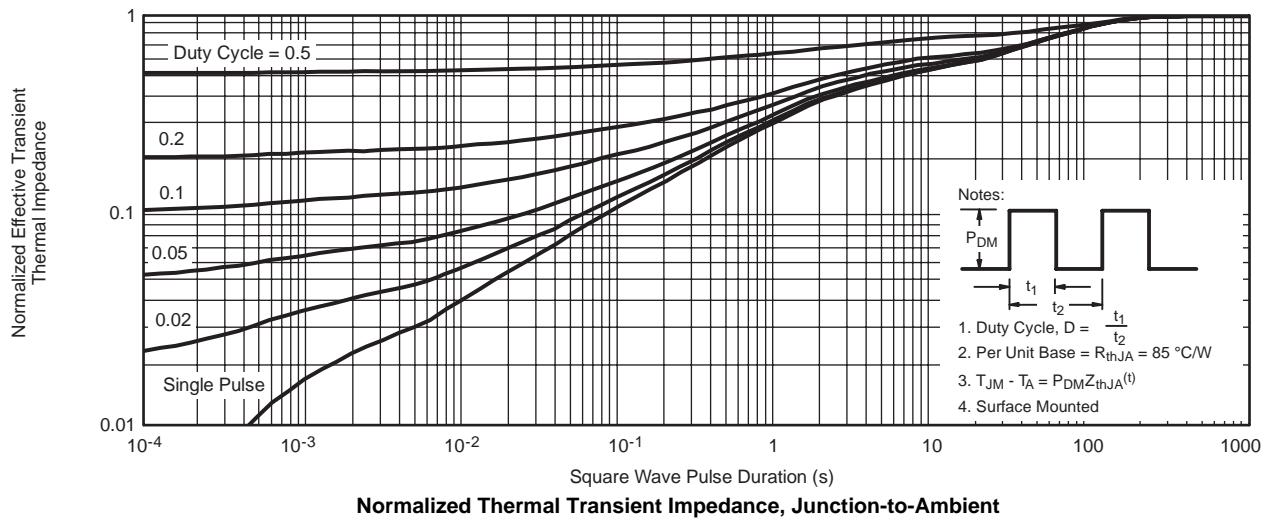


T<sub>A</sub> - Ambient Temperature (°C)

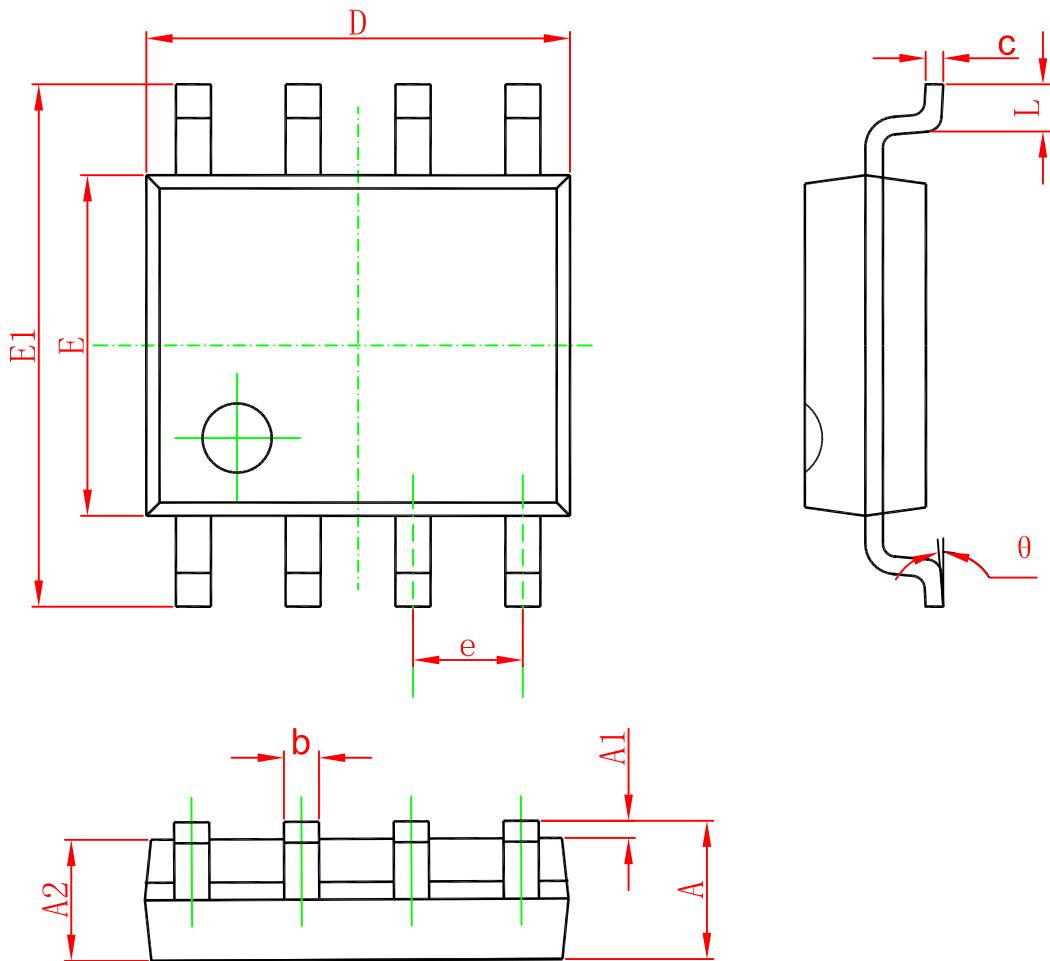
**Power Derating, Junction-to-Ambient**

The power dissipation  $P_D$  is based on  $T_{J(\max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

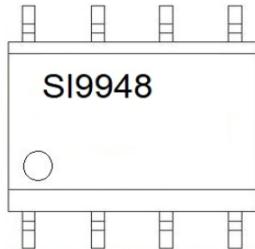


**SOP-8**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

## Marking



## Ordering information

Order code	Package	Baseqty	Deliverymode
SI9948AEY	SOP-8	3000	Tape and reel